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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Perino et al.

Confirmation No.: 4507

Application No.: 09/961,114

Group Art No.: 2833

Filed: September 20, 2001

Examiner: Figueroa, Felix O.

For:

Chip Socket and Chip File Assembly

for Semiconductor Chips

Attorney Docket No.: 60809-5054-US (formerly RB1-035USC3US)

# TRANSMITTAL OF REVOCATION AND POWER OF ATTORNEY

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Applicant's representative encloses herewith a Revocation and Power of Attorney and Statement under 37 C.F.R. §3.73(b) for the application number listed above. Applicant's attorney requests that the Power of Attorney be accepted and made of record.

Future correspondence should be forwarded to:

Customer No. 38426

No fee is believed owed with this submission. The Commissioner is authorized to charge any fees associated with this communication to our deposit account number 50-0310 (order no. 60809-5054-US). A copy of this sheet is enclosed for such purpose.

Respectfully submitted,

Date October 12, 2005

Dion M. Bregman

Reg. No. 45,645

MORGAN, LEWIS & BOCKIUS LLP

lle

2 Palo Alto Square

3000 El Camino Real, Suite 700 Palo Alto, California 94306

(640) 843-4000

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of:

See Schedule A

Serial No.:

See Schedule A

Filed:

See Schedule A

For:

See Schedule A

Attorney Docket No:

See Schedule A

#### REVOCATION AND POWER OF ATTORNEY

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

SIR:

Rambus, Inc. owner of the entire right, title and interest in, to and under the inventions listed in Schedule A hereby revokes all previous powers of attorney and appoints Morgan, Lewis & Bockius LLP, Customer No. 38426, and each of them, its attorneys, prosecute these matters, and to transact all business in the Patent and Trademark Office connected therewith, said appointment to be to the exclusion of the inventors and their attorney(s) in accordance with the provisions of 37 C.F.R. 3.71, provided that, if any one of these attorneys ceases being affiliated with the law firm of Morgan, Lewis & Bockius LLP as partner, counsel, or employee, then the appointment of that attorney and all powers derived therefrom shall terminate on the date such attorney ceases being so affiliated.

In addition, the undersigned assignee also appoints Kent R. Richardson (Reg. No. 39,443), Paul M. Anderson (Reg. No. 39,896), Paula J. Lagattuta (Reg. No. 40,691), Jose G. Moniz (Reg. 50,192) and Lance Kreisman (Reg. No. 39,256) of Rambus Inc., to prosecute these matters and to transact all business in the Patent and Trademark Office connected therewith.

Please direct all future correspondence to the address associated with Customer No. 38426, Morgan, Lewis & Bockius LLP and direct all telephone calls to Morgan, Lewis & Bockius LLP at (650) 843-4000.

Assignee:

Rambus, Inc

Date:

6/20/05

Signature:

Typed Name:

Position/Title:

Address:

VICE PRESIDENT INTELLECTU

4440 El Camino Real

Mountain View, California 94022

1-PA/3549237.1

# **SCHEDULE A**

Serial No./ Patent No.	Filing Date/ Issue Date	Title	First Named Inventor	Attorney Docket No.
09/468,247	12/20/1999	Chip Socket Assembly and Chip File Assembly for Semiconductor Chips (RA041.C1D1.US)	Donald V. Perino	60809-5051-US
6,352,435	03/05/2002			
09/957,815	09/20/2001	Chip Socket Assembly and Chip File Assembly for Semiconductor Chips (RA041.C1D1C1.US)	Donald V. Perino	60809-5052-US
6,619,973	09/16/2003			
09/957,822	09/20/2001	Chip Socket Assembly and Chip File Assembly for Semiconductor Chips (RA041.C1D1C2.US)	Donald V. Perino	60809-5053-US
6,589,059	07/08/2003			
09/961,114	09/20/2001	Chip Socket Assembly and Chip File Assembly for Semiconductor Chips (RA041.C1D1C3.US)	Donald V. Perino	60809-5054-US
09/594,221	06/14/2000	Method and Apparatus for Transmitting Data with Reduced Coupling Noise (RA163.P.US)	Mark A. Horowitz	60809-5055-US
11/130,502	05/17/2005	Method and Apparatus for Transmitting Data with Reduced Coupling Noise (RA163.CA.US)	Mark A. Horowitz	60809-5056-US
09/817,828	03/26/200	Clock Routing in Multiple	Ravindranath T.	60809-5057-US
6,590,781	07/08/2003	Channel Modules and Bus Systems (RA171.CIP1.US)	Kollipara	
10/420,308	04/22/2003	Clock Routing in Multiple Channel Modules and Bus Systems (RA171.CIP1D1.US)	Ravindranath T. Kollipara	60809-5058-US
09/679,143	10/03/2000	Semiconductor Stacked Die Devices (RA189.P.US)	Belgacem Haba	60809-5060-US
6,674,161	01/06/2004			
10/706,897	11/13/2003	Methods of Forming Semiconductor Stacked Die Devices (RA189.D1.US)	Belgacem Haba	60809-5061-US
6,902,953	06/07/2005			
11/123,641	05/06/2005	Semiconductor Stacked Die Devices and Methods for Forming Semiconductor Stacked Die Devices (RA189.D1C1.US)	Belgacem Haba	60809-5062-US
10/438,238	05/14/2003	Multilayer Flip-Chip Substrate Interconnect Layout (RA291.P.US)	Hao Shi	60809-5063-US

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Chip Socket Assembly and Chip

Attorney Docket No.:

60809-5054-US

File Assembly for Semiconductor

(formerly RB1-035USC3)

Chips

#### STATEMENT UNDER 37 C.F.R. § 3.73(b)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Rambus Inc., a corporation, states that it is the assignee of the entire right, title and interest in the patent application/patent identified above by virtue of an assignment from the inventor(s) of the patent application/patent identified above.

The assignment of the parent application 08/452,120 (abandoned) was recorded in the United States Patent and Trademark Office on August 22, 1995 at Reel 7592, Frame 0442, or for which a copy thereof is attached.

The undersigned is authorized to act on behalf of the assignee.

Date:

October 12, 2005

45,645

(Reg. No.)

Dign M. Bregman

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